Harvatek Surface Mount CHIP LEDs Data Sheet B3C73RBG-K9C-0001H4 (Preliminary)

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		Preliminary
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DISCLAIMER
LIFE SUPPORT POLICY
PRODUCT SPECIFICATIONS
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION4
LABEL SPECIFICATIONS
SPECIFICATIONS RANGE
PRODUCT FEATURES
ELECTRO-OPTICAL CHARACTERISTICS9
PACKAGE OUTLINE DIMENSION AND RECOMMENDED SOLDERING PATTERN FOR REFLOW
Soldering
PRECAUTION FOR USE11
PACKAGING
TAPE DIMENSION
REEL DIMENSION13
Packing
Dry Раск14
Baking14
PRECAUTIONS14
REFLOW SOLDERING
Reworking15
CLEANING15
CAUTIONS OF PICK AND PLACE16
REVISE HISTORY16

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		Preliminary
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 2/15

DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		Preliminary
	Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		Version 1.0	Page 3/15

Product Specifications

Item	Specification	Material	Quantity
Luminous	50-135 mcd		
Intensity(Iv)	R@0.9mA B@0.65mA G@1mA		
	Ts= 25 $^{\circ}$ C; Tolerance ±10%		
Chromaticity	AS page 6 & 7		
Coordinate	R@0.9mA B@0.65mA G@1mA		
	Ts = 25 $^{\circ}$ C;Tolerance: + 0.007		
Vf	R:1.6-2.6 V		
	B : 2.0-3.0 V		
	G:2.0-3.0 V		
	R@0.9mA B@0.65mA G@1mA		
	Ts= 25 O C;Tolerance ± 0.05V		
Ir	< 100 µA @ V _R = 5V		
Resin	Water clear	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	4000ea/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin

combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note : This is shipped test conditions

%Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product,

such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



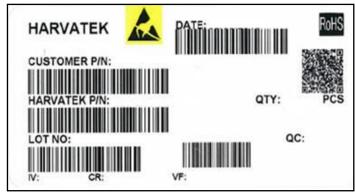
The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

be taken during design and assembly.

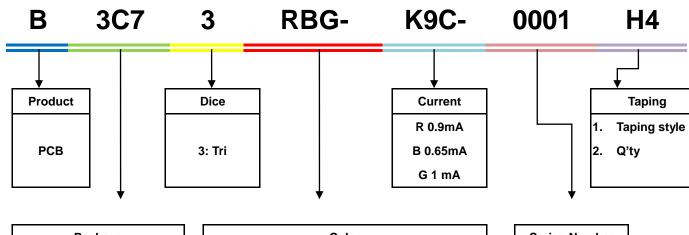
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****	Preliminary	
	Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential		Version 1.0	Page 4/15

Label Specifications



Harvatek P/N:



Package	Color	Series Number
1.0(L)x1.0(W)x0.25(H) mm	RBG(White)	0001~ZZZZ

Lot No.:

1 2	3	4	5	6	7	8	9	10
E 1	Α	1	Α	2	2	L	1	2
Code 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special coo	le
Internal Tracing Code	2010-A 2011-B 2012-C 2013-D	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	~72		000~ZZZ	Z

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		Preliminary
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 5/15

Specifications Range

■Electro-Optical Characteristics (Ta=25°C):

Color	Color	MIN	МАХ	Condition
Lumineur letereitu	Red	22.5	71.5	
Luminous Intensity (IV)	Blue	14.5	45	
(17)	Green	71.5	180	
	Red	620	630	
Dominant Wavelength	Blue	466	475	IF=2mA
(WD)	Green	523	539	
Forward Voltage	Red	1.6	2.4	
	Blue	2.4	3.4	
(∨f)	Green	2.4	3.4	

*Just for reference.

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	****	*****		Preliminary
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 6/15

Luminous Intensity (Iv) Bin:

Color	Bin Code	MIN	MAX	Condition
	P1	45	56	
	P2	56	71.5	R: IF=0.9mA
White	Q1	71.5	90	G: IF=1mA
	Q2	90	112.5	B: IF=0.65mA
	R1	112.5	140	

Note: It maintains a tolerance of ±10% on luminous intensity

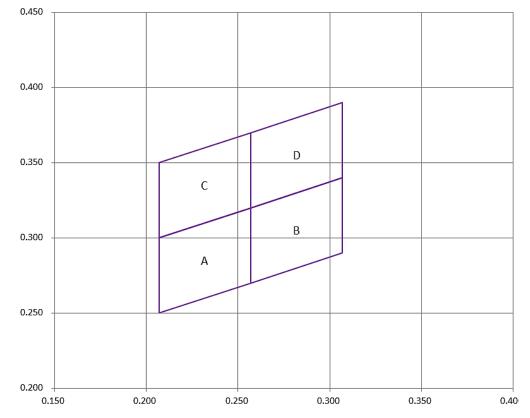
■Color Bin:

	Bin Code	CIE_x	BIN CODE	CIE_y
W/b:4-	Α	0.2070.2500.2070.3000.2570.3200.2570.270	В	0.2570.2700.2570.3200.3070.3400.3070.290
White	С	0.2070.3000.2070.3500.2570.3700.2570.320	D	0.2570.3200.2570.3700.3070.3900.3070.340

Note: It maintains a tolerance of x,y ± 0.007

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****	Preliminary	
1	to changes for improvement without ata, drawings, company confidential	08/07/2017	Version 1.0	Page 7/15

■CIE Chromaticity Diagram



■Forward Voltage (Vf) Bin:

	HT-B3C73RGB Series								
	Vf								
	Red			Green			Blue		
1	1.7	1.9	1	2.7	2.76	1	2.45	2.55	
2	1.9	2.1	2	2.76	2.82	2	2.55	2.65	
3	2.1	2.3	3	2.82	2.88	3	2.65	2.75	
			4	2.88	2.94	4	2.75	2.85	
			5	3	3.06	5	2.85	2.95	
			6	3.06	3.12	6			
			7	3.12	3.18	7			

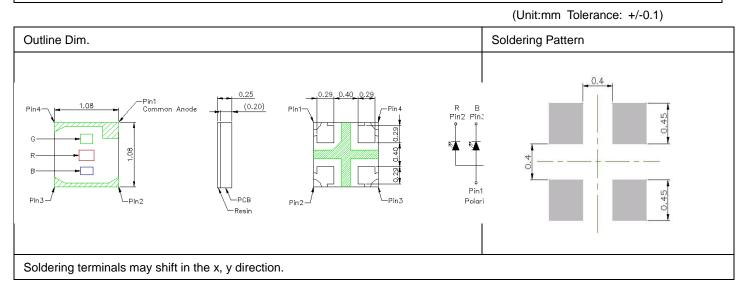
Note: It maintains a tolerance of ±0.05V on forward voltage measurements

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****	Preliminary	
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 8/15

Product Features

Electro-Optical	Characteris	tics							
		I					oldering , 25 °C)		
Series	Lightting	Forward V	Voltage(V)	l [*] v(mcd)			•		
Jenes	Color	typ.	max		min	max	I _F (mA)		
	Red	1.8	2.4	White	W/bite	White			R 0.9 mA
B3C73RBG-J9	Blue	2.4	3.0		45	135	B 0.65 mA		
	Green	2.5	3.0				G 1 mA		

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering



($T_{Soldering} \, 25\, {}^\circ \! {\rm C}$)

Absolute Maximum Ratings

Series	P _D (mW)	I _F (mA)	Vr(V)	I _{FP} (mA)	T _{OP} (°C)	T _{ST} (°C)
Color	Power Dissipation	Forward Current	Reverse Voltage	Pulse Forward Current	Color	Power Dissipation
Red		0.9				
Blue	12.75	0.65	5	20	-40~+85	-40~+100
Green		1				

*Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

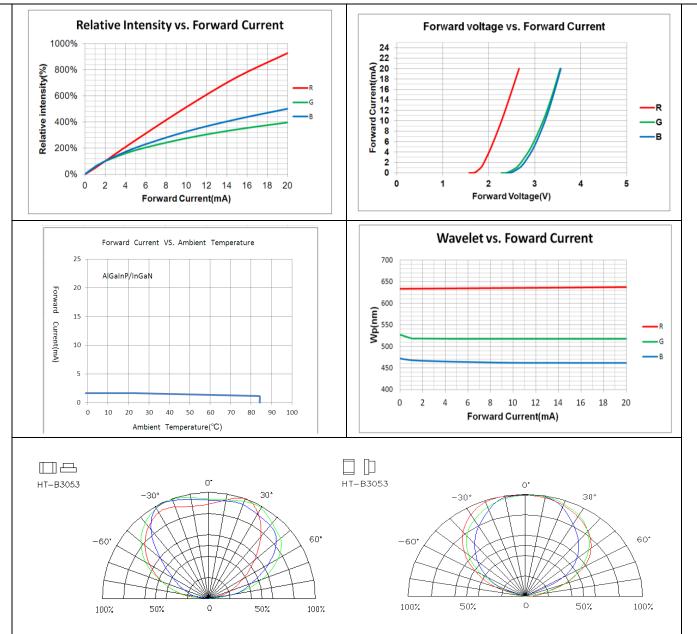
*Remarks:This product should be operated in forward bias.If a reverse voltage is continuously

applied to the product, such operation can cause migration resulting in LED damage.

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****	Preliminary	
	to changes for improvement without y data, drawings, company confidential	08/07/2017	Version 1.0	Page 9/15



Characteristics of B3C73RBG – J9



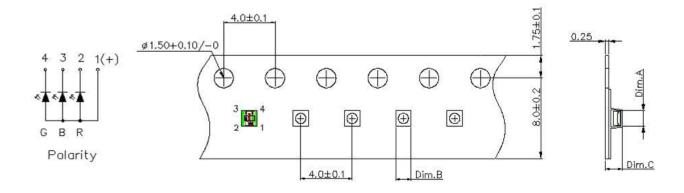
Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	****	*****	Preliminary	
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 10/15

Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

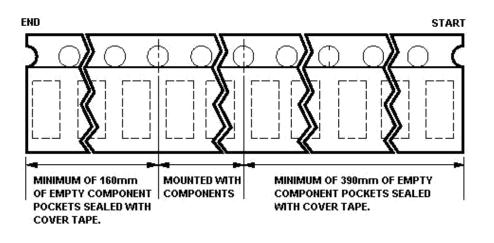
Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		Preliminary
	to changes for improvement without v data, drawings, company confidential	08/07/2017	Version 1.0	Page 11/15

Packaging Tape Dimension



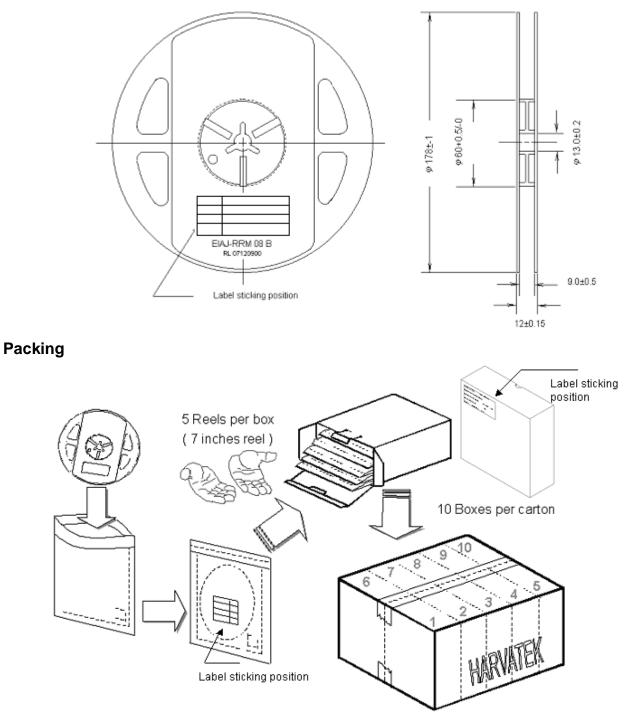
Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.23±0.05	1.23±0.05	0.42±0.05	4K
nit: mm			

```
nit: mm
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Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****	Preliminary	
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 12/15

Reel Dimension



5 boxes per carton is available depending on shipment quantity.

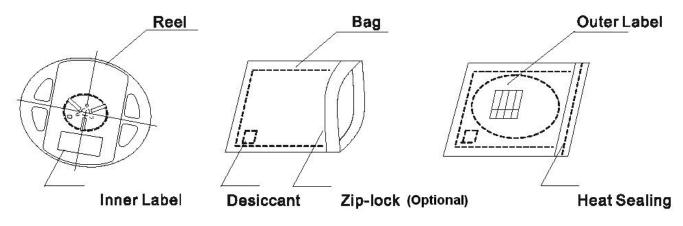
Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		Preliminary
	to changes for improvement without / data, drawings, company confidential	08/07/2017	Version 1.0	Page 13/15

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1. $60\pm3^{\circ}C\times(12\sim24hrs)$ and <5% RH, taped reel type.
- 2. 100±3°C ×(45min~1hr), bulk type.
- 3. 130±3°C ×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

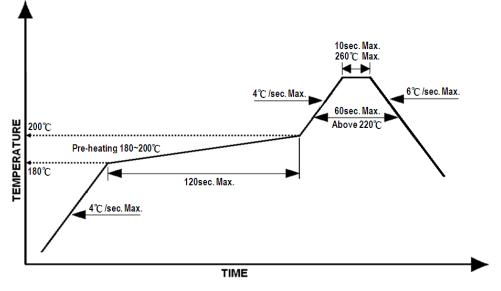
Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		Preliminary
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 14/15

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above $220^{\circ}C$,60 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 $^\circ\!\mathbb{C}.$
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Official Product HT Part No. B	3C73RBG-K9C-0001H4 Cu	Customer Part No.		Data Sheet No.
Tentative Product *********	**** **	*****		Preliminary
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 15/15

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
1.0	-	08/07/2017	-

Official Product	HT Part No. B3C73RBG-K9C-0001H4	Customer Part No.		Data Sheet No.
Tentative Product	*****	*****		Preliminary
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		08/07/2017	Version 1.0	Page 16/15